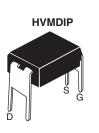
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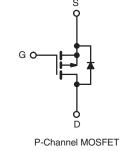
RoH

COMPLIANT

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 100			
R _{DS(on)} (Ω)	$V_{GS} = -10 V$	0.60		
Q _g (Max.) (nC)	18			
Q _{gs} (nC)	3.0			
Q _{gd} (nC)	9.0			
Configuration	Single			





FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- P-Channel
- 175 °C Operating Temperature
- · Fast Switching
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD9120PbF
	SiHFD9120-E3
SnPb	IRFD9120
	SiHFD9120

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	- 100	v		
Gate-Source Voltage	V _{GS}	± 20			
Continuous Drain Current	V_{GS} at - 10 V $\frac{T_A = 25 \degree C}{T_A = 100 \degree C}$	- I _D	- 1.0		
	$T_A = 100 $ °C		- 0.70	А	
Pulsed Drain Current ^a	I _{DM}	- 8.0			
Linear Derating Factor		0.0083	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	140	mJ		
Repetitive Avalanche Current ^a	I _{AR}	- 1.0	А		
Repetitive Avalanche Energy ^a	E _{AR}	0.13	mJ		
Maximum Power Dissipation	T _A = 25 °C	PD	1.3	W	
Peak Diode Recovery dV/dt ^c		dV/dt	- 5.5	V/ns	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	•••	
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = - 25 V, starting T_J = 25 °C, L = 52 mH, R_g = 25 Ω , I_{AS} = - 2.0 A (see fig. 12).

c. $I_{SD} \leq$ - 6.8 A, dI/dt \leq 110 A/µs, $V_{DD} \leq V_{DS},\,T_J \leq$ 175 °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	120	°C/W	

PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	$V_{GS} = 0 V, I_D = -250 \mu A$		-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C, I _D = - 1 mA	-	- 0.10	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = - 250 μΑ	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zara Cata Valtaga Drain Current	1	V _{DS} = - 100 V, V _{GS} = 0 V		-	-	- 100	μA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 80 ^v	V_{DS} = - 80 V, V_{GS} = 0 V, T_{J} = 150 °C		-	- 500	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 0.6 A ^b	-	-	0.60	Ω
Forward Transconductance	g _{fs}	V _{DS} = ·	- 50 V, I _D = - 0.60 A ^b	0.71	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$		390	-	
Output Capacitance	Coss	$V_{DS} = -25 V$ f = 1.0 MHz, see fig. 5		-	170	-	pF
Reverse Transfer Capacitance	C _{rss}			-	45	-	1
Total Gate Charge	Qg		I _D = - 6.8 A, V _{DS} = - 80 V see fig. 6 and 13 ^b	-	-	18	nC
Gate-Source Charge	Q_gs	$V_{GS} = - 10 V$		-	-	3.0	
Gate-Drain Charge	Q _{gd}			-	-	9.0	
Turn-On Delay Time	t _{d(on)}		V_{DD} = - 50 V, I _D = - 6.8 A R _g = 18 Ω, R _D = 7.1 Ω, see fig. 10 ^b		9.6	-	- ns
Rise Time	t _r	V _{DD} =			29	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 18 \Omega,$			21	-	
Fall Time	t _f				25	-	
Internal Drain Inductance	L _D	6 mm (0.25") f	Between lead, 6 mm (0.25") from		4.0	-	24
Internal Source Inductance	L _S	die contact		-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	showing the			-	- 1.0	A
Pulsed Diode Forward Current ^a	I _{SM}	p - n junction diode		-	-	- 8.0	
Body Diode Voltage	V _{SD}	T _J = 25 °C,	$T_{J} = 25 \text{ °C}, I_{S} = -1.0 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	- 6.3	V
Body Diode Reverse Recovery Time	t _{rr}	– T _J = 25 °C, I _F = - 6.8 A, dl/dt = 100 A/µs ^b		-	98	200	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.33	0.66	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	v Le and	Lo)

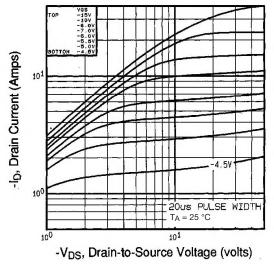
Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

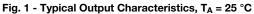
b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



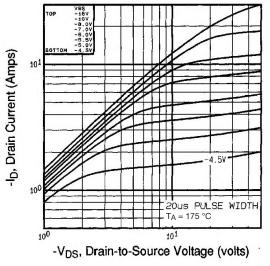
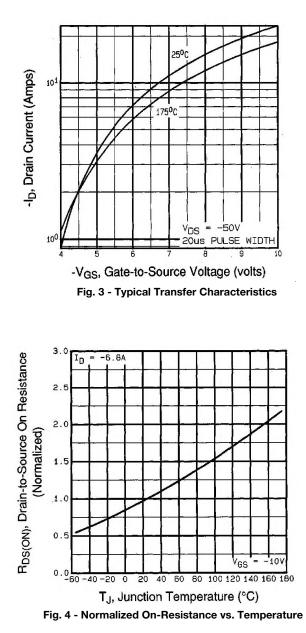


Fig. 2 - Typical Output Characteristics, $T_A = 175 \ ^\circ C$



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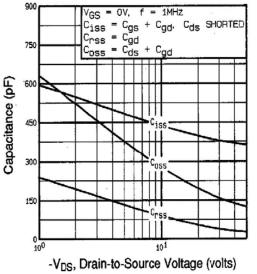
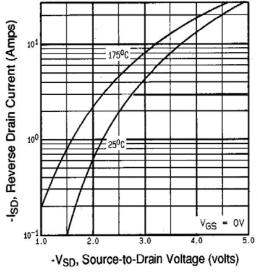


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





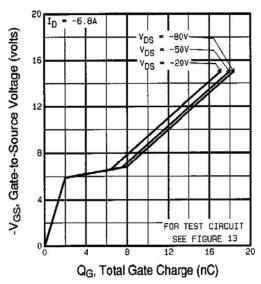
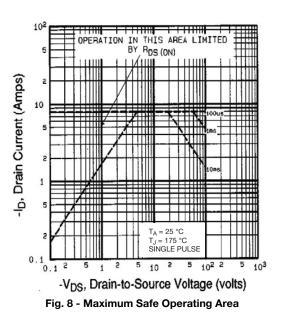


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





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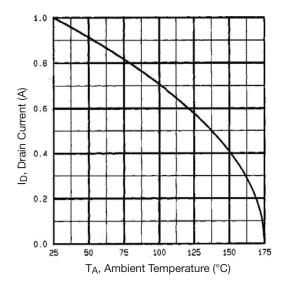


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

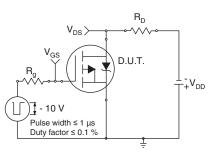


Fig. 10a - Switching Time Test Circuit

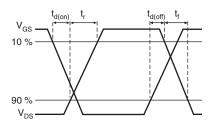


Fig. 10b - Switching Time Waveforms

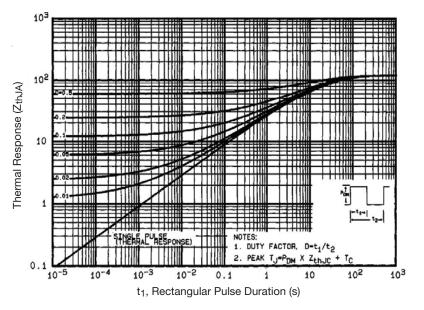


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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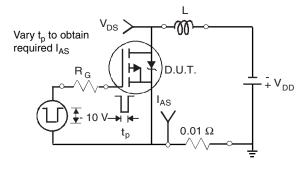


Fig. 12a - Unclamped Inductive Test Circuit

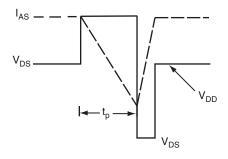


Fig. 12b - Unclamped Inductive Waveforms

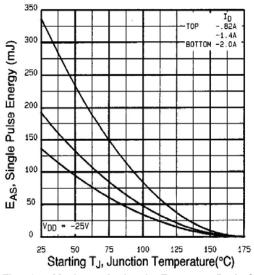
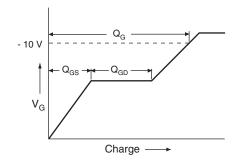


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





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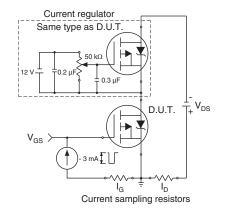
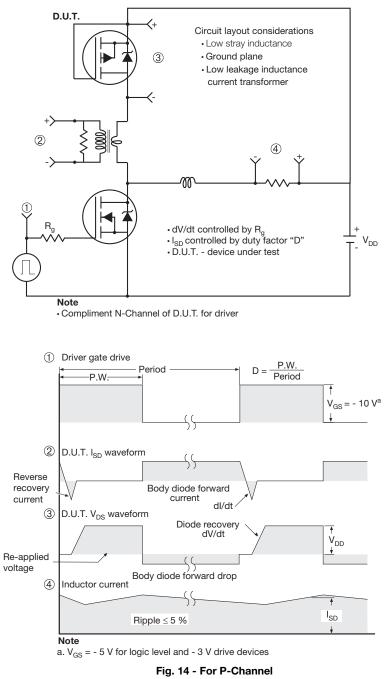


Fig. 13b - Gate Charge Test Circuit



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